

## Supporting Information

# Numerical evaluation of bi-facial ZnO/MoTe<sub>2</sub> photovoltaic solar cells with N-doped Cu<sub>2</sub>O as BSF layer focuses on enhancing V<sub>OC</sub> via device simulation

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# S1

## Recombination analysis of n-ZnO/p-MoTe<sub>2</sub>-based PVSC with and without p<sup>+</sup>-N:Cu<sub>2</sub>O-BSF layer

Defect assisted recombination called Shockley-read-Hall (SRH) recombination is the most dominant recombination process among the various recombination process in solar cells which able to deteriorate the cell performance mostly. SRH recombination statistics as well as analytical approximation can be performed to understand the qualitative and quantitative extraction of recombination rates at cell regions of the devices such as at the ETL/absorber interface ( $R^{i,f}$ ), in the depletion region ( $R^d$ ), in the bulk region zone ( $R^b$ ), and at the BSF layer/absorber interface ( $R^{i,b}$ ).<sup>1</sup> However, the bias voltage ( $V$ ) and the temperature dependent recombination rates can be expressed as follows:<sup>1</sup>

$$R^{i,f} = R_0^{i,f} e^{\frac{qV}{K_B T}} \quad (1)$$

$$R^d = R_0^d e^{\frac{qV}{2K_B T}} \quad (2)$$

$$R^b = R_0^b e^{\frac{qV}{K_B T}} \quad (3)$$

$$R^{i,b} = R_0^{i,b} e^{\frac{qV}{K_B T}} \quad (4)$$

Where  $K_B$  defines the Boltzmann constant and  $R_0^{i,f}$ ,  $R_0^d, R_0^b$  and  $R_0^{i,b}$  represent the recombination coefficient at the ETL/absorber interface, in the depletion region, in the bulk region zone, and at the BSF layer/absorber interface with zero bias voltage ( $V=0$ ), in that order. These coefficients ( $R_0^{i,f}$ ,  $R_0^d, R_0^b$  and  $R_0^{i,b}$ ) are essential for the intrinsic properties of material or devices and show effectiveness of the corresponding recombination pathways. The mathematical formula for recombination coefficients ( $R_0^{i,f}$ ,  $R_0^d, R_0^b$  and  $R_0^{i,b}$ ) are expressed as follows:<sup>1</sup>

$$R_0^{i,f} = S_h^f N_V e^{\frac{q\phi_{b0}}{K_B T}} \quad (5)$$

$$R_0^d = \frac{W_d}{\tau_e + \tau_h} n_i \quad (6)$$

$$R_0^b = \frac{W n_i^2}{\tau_e N_A} \quad (7)$$

$$R_0^{i,b} = S_e^b N_C e^{\frac{E_g - \varepsilon_b}{K_B T}} \quad (8)$$

where  $S_h^f/S_e^b$  represent the surface recombination velocity of hole/electron at front/back interface,  $\phi_{b0}$  is the potential barrier for majority carrier at the interface,  $q$  ascribes the electric charge,  $W_d$  defines depletion width,  $\tau_e/\tau_h$  are the minority carrier lifetime for electron/hole in the quasi-neutral region,  $W$  is the absorber thickness,  $N_A$  defines the acceptor density,  $N_C/N_V$  describe the effective conduction/valance band density,  $E_g$  is the band gap of absorber layer,  $\varepsilon_b$  is the bulk Fermi-energy separation from the valence band edge.

Now, focusing on the open circuit voltage  $V_{OC}$ , assuming that total generation across the absorber layer  $G_a W$  ( $W$ =width of the absorber layer) is equal to the total recombination ( $\sum R = R^{i,f} + R^d + R^b + R^{i,b}$ ), which expressed as:

$$(R_0^{i,f} + R_0^b + R_0^{i,b}) e^{\frac{qV_{OC}}{K_B T}} + R_0^d e^{\frac{qV_{OC}}{2K_B T}} = G_a W \quad (9)$$

Now solving the Eqn (9) and the  $V_{OC}$  can be expressed as follow:

$$V_{OC} = \frac{2K_B T}{q} \ln \left[ K_1 (\sqrt{G_a K_2 + 1} - 1) \right] \quad (10)$$

Where,

$$K_1 = \frac{1}{2R_0^{i,f} + R_0^b + R_0^{i,b}} \quad (11)$$

$$K_2 = \frac{4W(R_0^{i,f} + R_0^b + R_0^{i,b})}{(R_0^d)^2} \quad (12)$$

Using Eqn. (11) and Eqn. (12), the recombination coefficient in the SCR zone is

$$R_0^d = \frac{2W}{K_1 K_2} \quad (13)$$

It is clearly observed that the recombination coefficient in the SCR zone  $R_0^d$ , can be calculated by extracting the values of  $K_1$  and  $K_2$  from the intensity dependent  $V_{OC}$  analysis under the white light irradiation condition.

The intensity dependent  $V_{OC}$  analysis under monochromatic short and long wavelength are carried out to extract the recombination coefficient at absorber/BSF interface ( $R_0^{i,b}$ ), and surface recombination velocity of electrons at absorber/BSF interface ( $S_e^b$ ). As the photons energy of SW light source (blue) is well above the band gap of the absorber material, electron and hole pairs are generated near the surface region resulting the most of the SRH recombination is taken place in the vicinity of the front interface (ZnO/MoTe<sub>2</sub> interface), which make the recombination at the back interface is approximately zero ( $R_0^{i,b} \sim 0$ ). Therefore, under monochromatic SW light illumination, the coefficient of  $K_1$  and  $K_2$  can be written as:

$$K_1^{SW} = \frac{1}{2} \frac{R_0^d}{R_0^{i,f} + R_0^b} \quad (14)$$

$$K_2^{SW} = \frac{4W(R_0^{i,f} + R_0^b)}{(R_0^d)^2} \quad (15)$$

On the other side, the photons energy of LW light source (Red) is nearly equal to the band gap of the absorber, makes nearly uniform generation profile across the absorber layer and the coefficient of  $K_1$  and  $K_2$  can be expressed as:

$$K_1^{LW} = \frac{1}{2} \frac{R_0^d}{R_0^{i,f} + R_0^b + R_0^{i,b}} \quad (16)$$

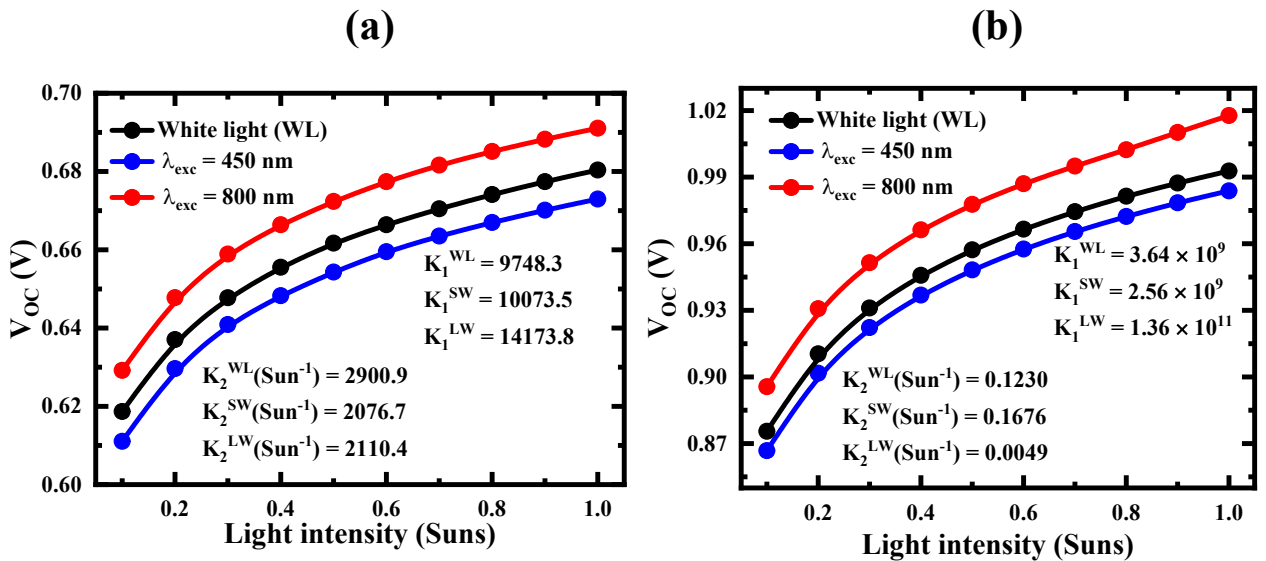
$$K_2^{LW} = \frac{4W(R_0^{i,f} + R_0^b + R_0^{i,b})}{(R_0^d)^2} \quad (17)$$

After simplification of Eqn. (14) and Eqn. (16), the recombination coefficient at the back interface can be obtained as:

$$R_0^{i,b} = \frac{1}{2} \left[ \frac{1}{K_1^{SW}} - \frac{1}{K_1^{LW}} \right] \times R_0^d \quad (18)$$

Now putting the value the recombination coefficient in the SCR zone ( $R_0^d$ ) have already obtained from Eqn. (13) in Eqn. (18) and we can get the value of the recombination coefficient at the back interface ( $R_0^{i,b}$ ). After that, the recombination rate in the depletion zone and absorber/BSF interface can be obtained utilizing Eqn. (2) and Eqn. (4), respectively from the known values of  $R_0^d$  and  $R_0^{i,b}$ . Finally, the surface recombination velocity of electrons at the back interface ( $S_e^b$ ) can be extracted by using Eqn. (8) from the known values of  $R_0^{i,b}$ ,  $N_C$ , and  $E_g - \varepsilon_b$ .

In this study, the two different monochromatic wavelengths (450 nm and 800 nm) are carried out to illuminate the designed PVSCs aiming to extract qualitative and quantitative information about the recombination at the back interface with and without N:Cu<sub>2</sub>O-BSF layer. **Fig. 1** shows the light intensity (Ga) dependent  $V_{OC}$  graphs for without **(a)** and with **(b)** N:Cu<sub>2</sub>O-BSF layer. The value of the coefficients  $K_1$  and  $K_2$  are extracted from the fitting of the intensity dependent  $V_{OC}$  curves of the **Fig. 1** by using **Eqn. (10)**, **Eqn. (11)**, and **Eqn. (12)**, and other recombination coefficients  $R_0^d$ ,  $R_0^{i,b}$ ,  $R^d$ , and  $R^{i,b}$  from  $K_1$  and  $K_2$  and the surface recombination velocity of electrons at the back interface ( $S_e^b$ ) from the extracted recombination coefficient are assembled in **Table 1**.



**Fig. 1.** Light intensity dependent Voc for (a) **n-ZnO/p-MoTe<sub>2</sub>** (b) **n-ZnO/p-MoTe<sub>2</sub>/p<sup>+</sup>-N:Cu<sub>2</sub>O** device with different excitation wavelength of white light (WL),  $\lambda_{exc} = 450$  nm, and  $\lambda_{exc} = 800$  nm at constant temperature of 300 K.

**Table 1** reveals that the recombination coefficient and rate in the depletion region and at the back interface, along with the SRV at the back interface for n-ZnO/p-MoTe<sub>2</sub>, are notably poor. However, by integrating a 100 nm thick N:Cu<sub>2</sub>O layer with n-ZnO/p-MoTe<sub>2</sub>, forming an n-ZnO/p-MoTe<sub>2</sub>/p<sup>+</sup>-N:Cu<sub>2</sub>O structure, there is a significant reduction in the recombination coefficient in the depletion region and at the back interface, from  $1.1 \times 10^8$  cm<sup>-2</sup>s<sup>-1</sup> to  $7.1 \times 10^6$  cm<sup>-2</sup>s<sup>-1</sup> and  $1.6 \times 10^3$  cm<sup>-2</sup>s<sup>-1</sup> to  $1.3 \times 10^{-3}$ , respectively. Consequently, the recombination rate in the depletion region and at the back interface is suppressed from  $2.77 \times 10^{16}$  cm<sup>-2</sup>s<sup>-1</sup> to  $1.75 \times 10^{15}$  and  $3.98 \times 10^{11}$  cm<sup>-2</sup>s<sup>-1</sup> to  $3.35 \times 10^5$ , respectively. Additionally, the SRV at the back interface is decreased from 200 cm/s to  $1.69 \times 10^{-3}$  cm/s by adding the N:Cu<sub>2</sub>O BSF layer. These findings imply that the electric field at the p-MoTe<sub>2</sub>/p<sup>+</sup>-N:Cu<sub>2</sub>O interface enhances hole transport from the MoTe<sub>2</sub> absorber layer to the back contact via the N:Cu<sub>2</sub>O-BSF layer, mitigating the flow of minority carriers (electrons) towards the p-MoTe<sub>2</sub>/p<sup>+</sup>-N:Cu<sub>2</sub>O junction, thus reducing the carrier recombination rate at the device's rear side.

**Table 1:** Extracted values of  $K_1$  and  $K_2$  from **Fig. 1** and recombination coefficient for MoTe<sub>2</sub> based PVSCs with and without N:Cu<sub>2</sub>O back surface field (BSF) layer. Here  $R_0^d$ ,  $R_0^{i,b}$ ,  $R_d$ ,  $R^{i,b}$ , and  $S_e^b$  are calculated at bias voltage of 1.0 V.

Condition	$K_1^{SW}$	$K_1^{LW}$	$K_1^{WL}$	$K_2^{SW}$	$K_2^{LW}$	$K_2^{WL}$	$R_0^d$ (cm <sup>-2</sup> s <sup>-1</sup> )	$R_0^{i,b}$ (cm <sup>-2</sup> s <sup>-1</sup> )	$R^d$ (cm <sup>-2</sup> s <sup>-1</sup> )	$R^{i,b}$ (cm <sup>-2</sup> s <sup>-1</sup> )	$S_e^b$ (cm/s)
without N:Cu <sub>2</sub> O- BSF layer	10073	14173. 8	9748.3	2076.7	2110.4	2901	$1.1 \times 10^8$	$1.6 \times 10^3$	$2.77 \times 10^{16}$	$3.98 \times 10^{11}$	200
with N:Cu <sub>2</sub> O- BSF layer	$2.56 \times 10^9$	$1.36 \times 10^1$ 1	$3.64 \times 10^9$	0.1676	0.0049	0.123	$7.1 \times 10^6$	$1.3 \times 10^{-3}$	$1.75 \times 10^{15}$	$3.35 \times 10^5$	$1.69 \times 10^{-3}$

## REFERENCES

1. S. Paul, S. Grover, I. L. Repins, B. M. Keyes, M. A. Contreras, K. Ramanathan, R. Noufi Z. Zhao, F. Liao, and J. V. Li, Analysis of Back-Contact Interface Recombination in Thin-Film Solar Cells, IEEE J. Photovoltaics 8(3) (2018) 871–878.